Power MOSFET

60 V, 9.8 m Ω , 50 A, Single N-Channel

Features

- Small Footprint (3.3 x 3.3 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- NVTFS5C673NLWF Wettable Flanks Product
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

| Parar | Symbol | Value | Unit | | |
|--|-----------------------------------|----------------------------|-----------------|-----|----|
| Drain-to-Source Voltag | V_{DSS} | 60 | V | | |
| Gate-to-Source Voltage | 9 | | V _{GS} | ±20 | V |
| Continuous Drain Cur- | | T _C = 25°C | I _D | 50 | Α |
| rent $R_{\theta,JC}$ (Notes 1, 2, 3, 4) | Steady | T _C = 100°C | | 35 | |
| Power Dissipation | State | T _C = 25°C | P_{D} | 46 | W |
| R _{θJC} (Notes 1, 2, 3) | | T _C = 100°C | 1 | 23 | |
| Continuous Drain Cur- | | T _A = 25°C | I _D | 13 | Α |
| rent R _{θJA} (Notes 1 & 3, 4) | Steady State | T _A = 100°C | | 9 | |
| Power Dissipation | | T _A = 25°C | P_{D} | 3.1 | W |
| R _{θJA} (Notes 1, 3) | | T _A = 100°C | 1 | 1.6 | |
| Pulsed Drain Current | T _A = 25 | °C, t _p = 10 μs | I _{DM} | 290 | Α |
| Operating Junction and | T _J , T _{stg} | -55 to +175 | °C | | |
| Source Current (Body D | I _S | 52 | Α | | |
| Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 2.3 A) | | | E _{AS} | 88 | mJ |
| Lead Temperature for Soldering Purposes (1/8" from case for 10 s) | | | TL | 260 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

| Parameter | Symbol | Value | Unit |
|---|-----------------|-------|------|
| Junction-to-Case - Steady State (Note 3) | $R_{\theta JC}$ | 3.2 | °C/W |
| Junction-to-Ambient - Steady State (Note 3) | $R_{\theta JA}$ | 48 | |

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Psi (Ψ) is used as required per JESD51-12 for packages in which substantially less than 100% of the heat flows to single case surface.
- 3. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- Continuous DC current rating. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

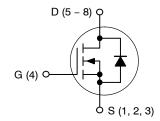


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| V _{(BR)DSS} | R _{DS(on)} MAX | I _D MAX | | |
|----------------------|-------------------------|--------------------|--|--|
| 60 V | 9.8 mΩ @ 10 V | 50 A | | |
| | 15 mΩ @ 4.5 V | 30 A | | |

N-Channel





WDFN8 (μ8FL) CASE 511AB



MARKING DIAGRAM

XXXX = Specific Device Code A = Assembly Location

Y = Year WW = Work Week • Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

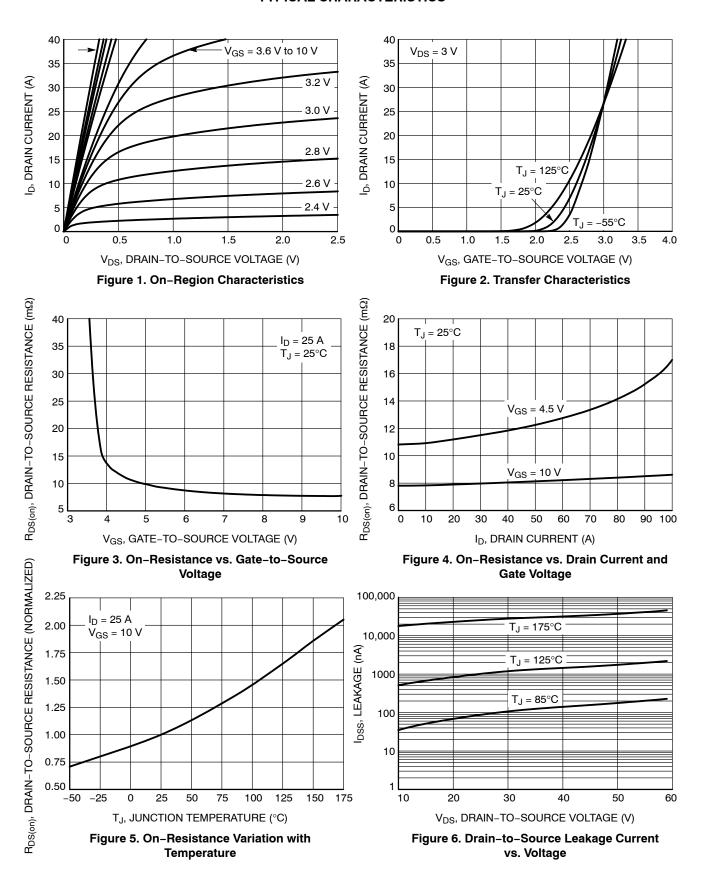
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

| Parameter | Symbol | Test Condition | | Min | Тур | Max | Unit |
|--|-------------------------------------|--|------------------------|-----|------|-----|-------|
| OFF CHARACTERISTICS | | | | | | | • |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | $V_{GS} = 0 \text{ V}, I_D =$ | = 250 μA | 60 | | | V |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | V _{(BR)DSS} / | | | | 28 | | mV/°C |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} = 0 V, | T _J = 25°C | | | 10 | |
| | | V _{DS} = 60 V | T _J = 125°C | | | 250 | μΑ |
| Gate-to-Source Leakage Current | I _{GSS} | V _{DS} = 0 V, V _{GS} = 20 V | | | | 100 | nA |
| ON CHARACTERISTICS (Note 5) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | $V_{GS} = V_{DS}, I_{D}$ | = 35 μΑ | 1.2 | | 2.0 | V |
| Threshold Temperature Coefficient | V _{GS(TH)} /T _J | | | | -4.5 | | mV/°C |
| Drain-to-Source On Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 25 A | | 8.1 | 9.8 | mΩ |
| | | V _{GS} = 4.5 V | I _D = 25 A | | 12 | 15 | |
| Forward Transconductance | 9 _{FS} | V _{DS} =15 V, I _D | ₎ = 25 A | | 37 | | S |
| CHARGES AND CAPACITANCES | | | | | | | • |
| Input Capacitance | C _{ISS} | V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V | | | 880 | | |
| Output Capacitance | Coss | | | | 450 | | pF |
| Reverse Transfer Capacitance | C _{RSS} | | | | 11 | | |
| Total Gate Charge | Q _{G(TOT)} | V _{GS} = 4.5 V, V _{DS} = 48 V; I _D = 25 A | | | 4.5 | | nC |
| Total Gate Charge | Q _{G(TOT)} | V _{GS} = 10 V, V _{DS} = 48 V; I _D = 25 A | | | 9.5 | | nC |
| Threshold Gate Charge | Q _{G(TH)} | V _{GS} = 10 V, V _{DS} = 48 V; I _D = 25 A | | | 1.0 | | |
| Gate-to-Source Charge | Q _{GS} | | | | 2.0 | | nC |
| Gate-to-Drain Charge | Q_{GD} | | | | 0.8 | | |
| Plateau Voltage | V_{GP} | | | | 2.9 | | V |
| SWITCHING CHARACTERISTICS (Note 6 | 3) | | | | • | • | • |
| Turn-On Delay Time | t _{d(ON)} | | | | 6.0 | | |
| Rise Time | t _r | V _{GS} = 10 V, V _D | e = 48 V. | | 25 | | ns |
| Turn-Off Delay Time | t _{d(OFF)} | I _D = 25 A, R _G | = 2.5 Ω | | 16 | | |
| Fall Time | t _f | | | | 2.0 | | 1 |
| DRAIN-SOURCE DIODE CHARACTERIS | TICS | | | | | | |
| Forward Diode Voltage | V_{SD} | V _{GS} = 0 V, | T _J = 25°C | | 0.9 | 1.2 | |
| | | I _S = 25 A | T _J = 125°C | | 0.8 | | V |
| Reverse Recovery Time | t _{RR} | V_{GS} = 0 V, dIs/dt = 100 A/ μ s, I_S = 25 A | | | 28 | | |
| Charge Time | ta | | | | 14 | | ns |
| Discharge Time | t _b | | | | 14 | | 1 |
| Reverse Recovery Charge | Q _{RR} | | | | 18 | | nC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Pulse Test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$. 6. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

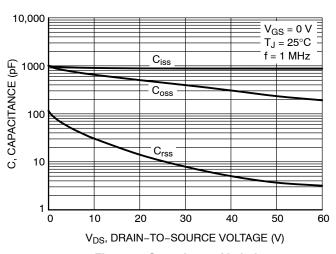


Figure 7. Capacitance Variation

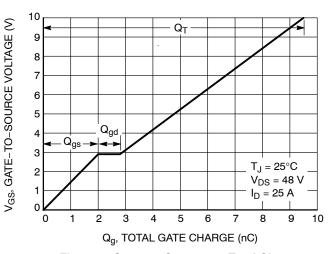


Figure 8. Gate-to-Source vs. Total Charge

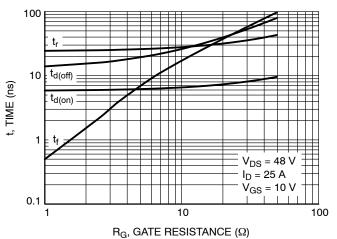


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

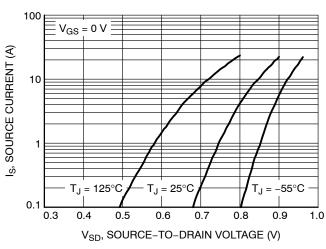


Figure 10. Diode Forward Voltage vs. Current

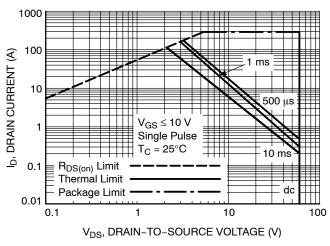


Figure 11. Maximum Rated Forward Biased Safe Operating Area

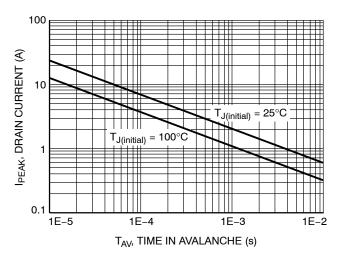


Figure 12. Maximum Drain Current vs. Time in Avalanche

TYPICAL CHARACTERISTICS

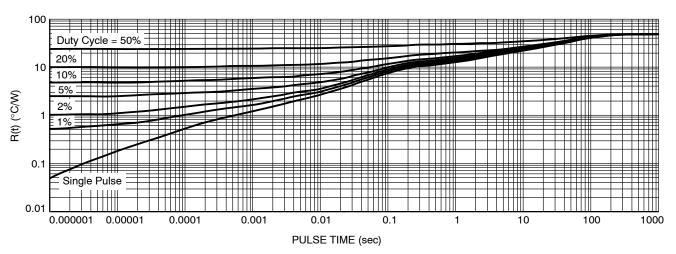


Figure 13. Thermal Response

DEVICE ORDERING INFORMATION

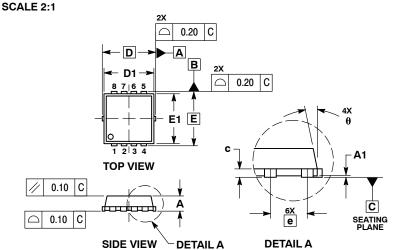
| Device | Marking | Package | Shipping [†] |
|-------------------|---------|-------------------------------------|-----------------------|
| NVTFS5C673NLTAG | 673L | WDFN8 (Pb-Free) | 1500 / Tape & Reel |
| NVTFS5C673NLWFTAG | 73LW | WDFN8 (Pb-Free, Wettable Flanks) | 1500 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



WDFN8 3.3x3.3, 0.65P CASE 511AB ISSUE D

DATE 23 APR 2012



NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION D1 AND E1 DO NOT INCLUDE MOLD FLASH
 PROTRUSIONS OR GATE BURRS.

| | MILLIMETERS | | | INCHES | | | |
|-----|-------------|----------|------|-----------|----------|-------|--|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX | |
| Α | 0.70 | 0.75 | 0.80 | 0.028 | 0.030 | 0.031 | |
| A1 | 0.00 | | 0.05 | 0.000 | | 0.002 | |
| b | 0.23 | 0.30 | 0.40 | 0.009 | 0.012 | 0.016 | |
| С | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | |
| D | | 3.30 BSC | | 0 | .130 BSC | ; | |
| D1 | 2.95 | 3.05 | 3.15 | 0.116 | 0.120 | 0.124 | |
| D2 | 1.98 | 2.11 | 2.24 | 0.078 | 0.083 | 0.088 | |
| E | 3.30 BSC | | | 0.130 BSC | | | |
| E1 | 2.95 | 3.05 | 3.15 | 0.116 | 0.120 | 0.124 | |
| E2 | 1.47 | 1.60 | 1.73 | 0.058 | 0.063 | 0.068 | |
| E3 | 0.23 | 0.30 | 0.40 | 0.009 | 0.012 | 0.016 | |
| е | 0.65 BSC | | | (| 0.026 BS | 0 | |
| G | 0.30 | 0.41 | 0.51 | 0.012 | 0.016 | 0.020 | |
| K | 0.65 | 0.80 | 0.95 | 0.026 | 0.032 | 0.037 | |
| L | 0.30 | 0.43 | 0.56 | 0.012 | 0.017 | 0.022 | |
| L1 | 0.06 | 0.13 | 0.20 | 0.002 | 0.005 | 0.008 | |
| М | 1.40 | 1.50 | 1.60 | 0.055 | 0.059 | 0.063 | |
| θ | 0 ° | | 12 ° | 0 ° | | 12 ° | |



GENERIC MARKING DIAGRAM*

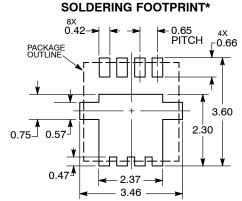


XXXXX = Specific Device Code = Assembly Location

= Year WW = Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.



DIMENSION: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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|------------------|----------------------|--|-------------|--|
| DESCRIPTION: | WDFN8 3.3X3.3, 0.65P | | PAGE 1 OF 1 | |

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